

Patent Application No. 10/657,847

24061.142

Customer Number: 42717

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Ai-Sen Liu, et al. 10/657,847

Examiner:

Docket No.:

(TSMC2002-1387)

Kiesha L. Rose

Filing Date:

99999999 September 9, 2003

Art Unit: 2822

For:

Serial No.:

Method for Forming Dielectric Barrier Layer in Damascene

Conf. No.:

2138

Structure

## RESPONSE TO RESTRICTION REQUIREMENT

Mail Stop: Amendment Commissioner for Patents PO Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action mailed January 11, 2005, applicant hereby elects, Group II, Claims 1-29, which is drawn to a method of making a semiconductor device.

Applicant's election is made with traverse on the grounds that the embodiments delineated by the examiner are not patentably distinct and therefore constitute a single invention concept.

An early action on the merits is respectfully requested.

Respectfully submitted,

David M. O'Dell Reg. No. 42,044

Date: 1-25-05

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I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Mail Stop: Amendment, Commissioner For Patents, PO Box 1450, Alexandria, VA 22313-1450 on the date below.

Name

Date